



## ASI-T-350EA6AN/D

Item	Contents	Unit
Size	3.5	inch
Resolution	320(RGB) x 240	/
Technology type	a-Si TFT	/
Interface	RGB	
Pixel pitch	0.219x0.219	mm
Pixel Configuration	R.G.B. Vertical Stripe	
Outline Dimension (W x H x D)	76.9 x 64.0 x 3.05	mm
Active Area	70.08 x 52.56	mm
Display Mode	Transmissive Normally White	/
Backlight Type	LED	/

Record of Revision

Date	Revision No.	Summary
2011-04-18	1.0	Rev 1.0 was issued
2013-09-16	1.1	IC update

# ASI-T-350EA6AN/D

## 1. Scope

This data sheet is to introduce the specification of ASI-T-350EA6AN/D active matrix TFT module. It is composed of a color TFT-LCD panel, driver ICs, FPC and a backlight unit. The 3.5" display area contains 320(RGB) x 240 pixels.

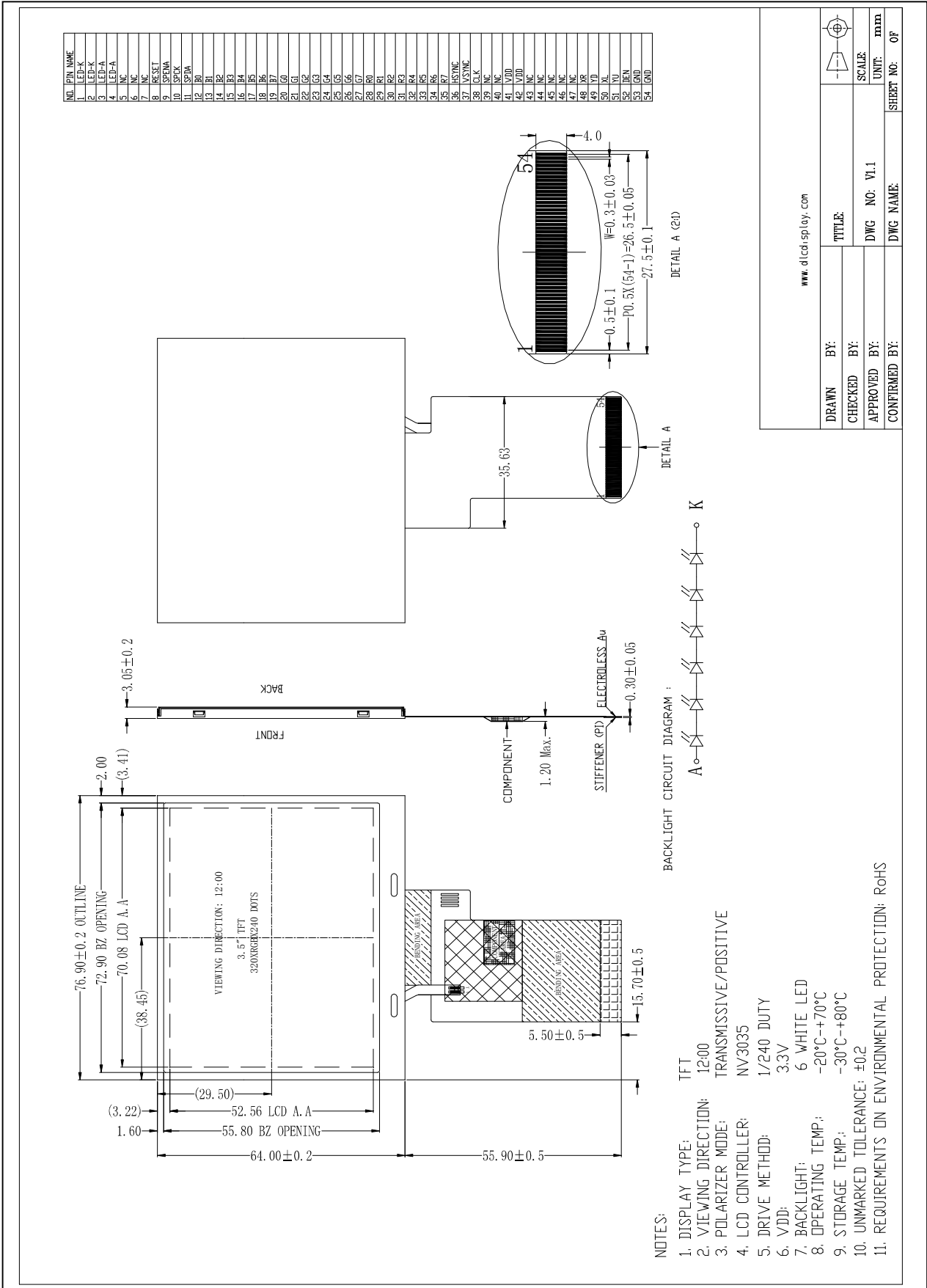
## 2. Application

Digital equipments which need color display, mobile phone, mobile navigator/video systems.

## 3. General Information

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4. Outline Drawing



## 5. Interface signals

Pin No.	Symbol	Description
1,2	LED-K	Backlight LED Cathode
3,4	LED-A	Backlight LED Anode.
5~7	NC	NC
8	RESET	Reset Signal pin ("Low" is enable)
9	SPENA	Serial port data enable signal
10	SPCK	SPI interface Clock
11	SPDA	SPI Serial Data Input/output
12~19	B0~B7	Data bus
20~27	G0~G7	Data bus
28~35	R0~R7	Data bus
36	HSYNC	Line Synchronous Signal
37	VSYNC	Frame Synchronous Signal
38	CLK	Dot Data Clock
39~40	NC	NC
41~42	VDD	Power supply
43~47	NC	NC
48	XR	Touch Pin
49	YD	Touch Pin
50	XL	Touch Pin
51	YU	Touch Pin
52	DEN	Data Enable Input
53~54	GND	System Ground

6. Absolute maximum Ratings

6.1. Electrical Absolute max. ratings

Item	Symbol	MIN	MAX	Unit	Remark
Power Supply Voltage	VDD	-0.3	5.0	V	

6.2. Environment Conditions

Item	Symbol	MIN	MAX	Unit	Remark
Operating Temperature	TOPR	-20	+70	°C	
Storage Temperature	TSTG	-30	+80	°C	

6.3. LED Backlight Absolute max. ratings

Item	Symbol	MIN	MAX	Unit	Remark
LED Forward Current	ILED	--	25	mA	For each LED

7. Electrical Specifications

7.1 Electrical characteristics

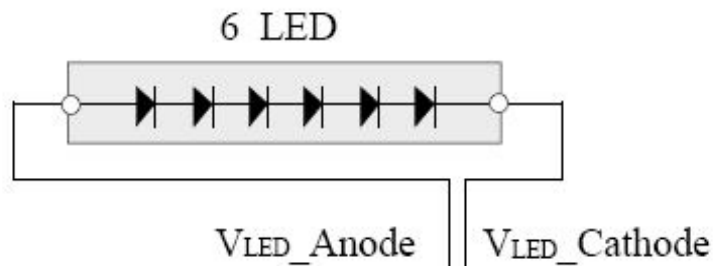
Item	Symbol	MIN	TYP	MAX	Unit	Remark
Supply Voltage	VDD	3	3.3	3.6	V	
Input Signal Voltage	Low Level VIL	GND	-	0.1x VDD	V	
	High Level VIH	0.8x VDD	-	VDD	V	
TFT Common Electrode	VcomH	2.5	-	4.5	V	
Voltage	VcomL	-3	-	0	V	
TFT Gata ON Voltage	VcomH			15	V	
TFT Gata OFF Voltage	VcomL	-10			V	

7.2 LED Backlight

Ta=25°C

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I <sub>F</sub>	--	20	25	mA	
Forward Current Voltage	V <sub>F</sub>	16.8	19.2	21.6	V	
Backlight Power Consumption	W <sub>BL</sub>	--	384	--	mW	

The figure below shows the connection of LED



8. Command/AC Timing

8.1 AC Electrical Characteristics

Test Condition: (VDD=VDDP=3.3V, VDDA=5.0V, GND=GNDA=GNDP=0V, TA= 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
<b>System Operation Timing</b>						
VDD power source slew time	T <sub>POB</sub>			1000	us	From 0V to 90% VDD
RSTB active pulse width	T <sub>RSTB</sub>	40			us	VDD = 3.3V
<b>Input Output Timing</b>						
CLKIN clock time	T <sub>clk</sub>	33.3/125	-	-	ns	Please refer to timing table(p.32)
HSD to CLKIN	T <sub>hc</sub>	-	-	1	CLKIN	
HSD width	T <sub>hwh</sub>	1	-	-	CLKIN	
VSD width	T <sub>vwh</sub>	1	-	-	Th	
HSD period time	T <sub>h</sub>	60	63.56	67	us	
VSD setup time	T <sub>vst</sub>	8	-	-	ns	
VSD hold time	T <sub>vhd</sub>	10	-	-	ns	
HSD setup time	T <sub>hst</sub>	8	-	-	ns	
HSD hold time	T <sub>hhd</sub>	10	-	-	ns	
Data set-up time	T <sub>dsu</sub>	8	-	-	ns	DIN[23:0] to CLKIN
Data hold time	T <sub>dhd</sub>	10	-	-	ns	DIN[23:0] to CLKIN
DEN setup time	T <sub>esd</sub>	12	-	-	ns	DEN to CLKIN
Time that VSD to 1 <sup>st</sup> line data input	T <sub>vs</sub>	2	13	127	Th	@CCIR601 / 8bit RGB HV mode Control by HDLY[6:0] setting T <sub>vs</sub> = HDLY[6:0]
Time that CCIR_V to 1 <sup>st</sup> line data input	T <sub>vs</sub>	12	20	28	Th	@CCIR656 NTSC mode Control by HDLY[6:0] setting T <sub>vs</sub> = HDLY[6:0]
Time that CCIR_V to 1 <sup>st</sup> line data input	T <sub>vs</sub> 17 25 33 Th					@CCIR656 PAL mode Control by HDLY[6:0] setting T <sub>vs</sub> = HDLY[6:0]
Time that VSD to 1 <sup>st</sup> line data input	T <sub>vs</sub>	2	13	127	Th	@24bit RGB HV mode Control by HDLY[6:0] setting T <sub>vs</sub> = HDLY[6:0]
Source output stable time 1	T <sub>st</sub>	-	25	30	us	96% final, CL=30pF, RL=2K
Gate output stable time	T <sub>gst</sub>	-	500	1000	ns	96% final, CL=40pF
VCOMOUT output stable time	T <sub>cst</sub>	-	4	8	us	96% final, CL=33nF, RL=100ohm
<b>3-wire serial communication AC timing</b>						
Serial clock	T <sub>spck</sub>	320	-	-	ns	
SPCK pulse duty		40	50	60	%	T <sub>ckh</sub> / T <sub>spck</sub>
Serial data setup time	T <sub>isu</sub>	120	-	-	ns	
Serial data hold time	T <sub>ihd</sub>	120	-	-	ns	
Serial clock high/low	T <sub>ckh/l</sub>	120	-	-	ns	
Chip select distinguish	T <sub>cd</sub>	1	-	-	us	
SPENB to VSD	T <sub>cv</sub>	1	-	-	us	
SPENB input setup time	T <sub>eck</sub>	150	-	-	ns	
SPENB input hold time	T <sub>cke</sub>	150	-	-	ns	

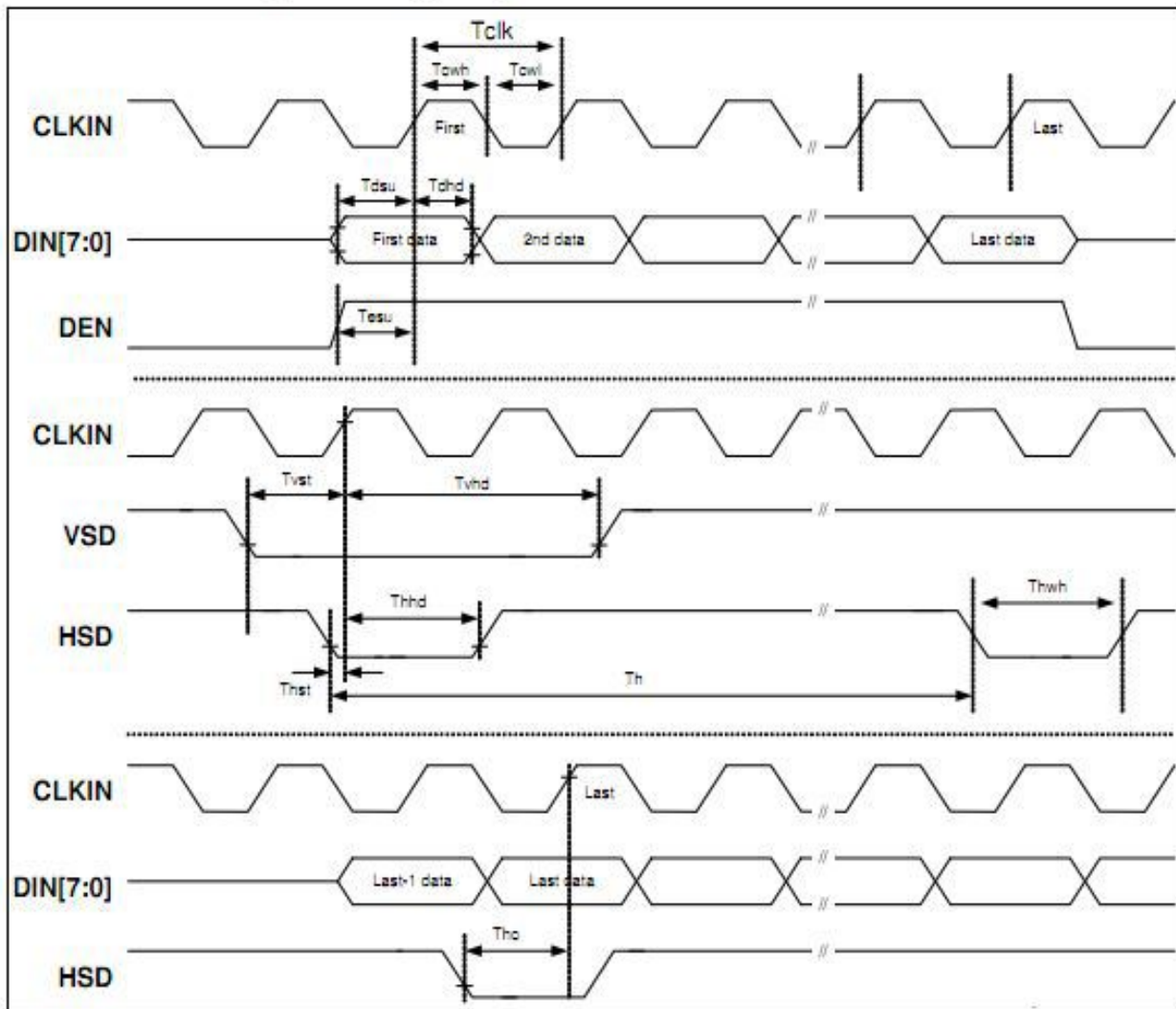
8.2 24 Bit RGB Mode (@ SEL[3:0] = 1100 or 1101)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
CLKIN frequency	F <sub>clk</sub>	6.1	6.4	8.0	MHz	VDD = 3.0 ~3.6V
CLKIN cycle time	T <sub>clk</sub>	125	156	164	ns	
CLKIN pulse duty	T <sub>cwh</sub>	40	50	60	%	T <sub>clk</sub>
Time that HSD to 1 <sup>st</sup> data input(NTSC)	T <sub>hs</sub>	40	70	255	CLKIN	DDL' =70, Offset = 0 (fixed)

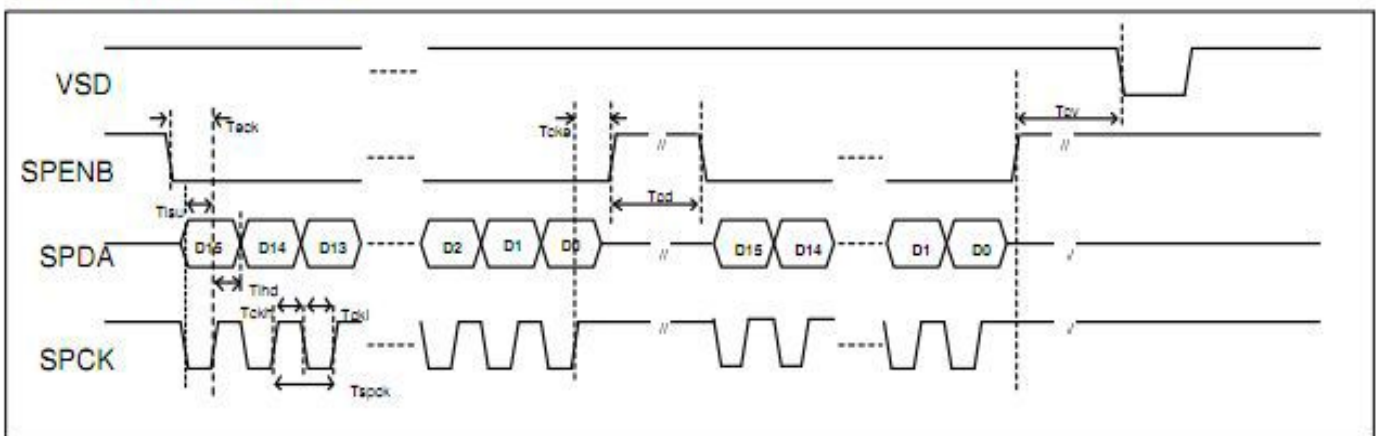


8.3 Timing Diagram

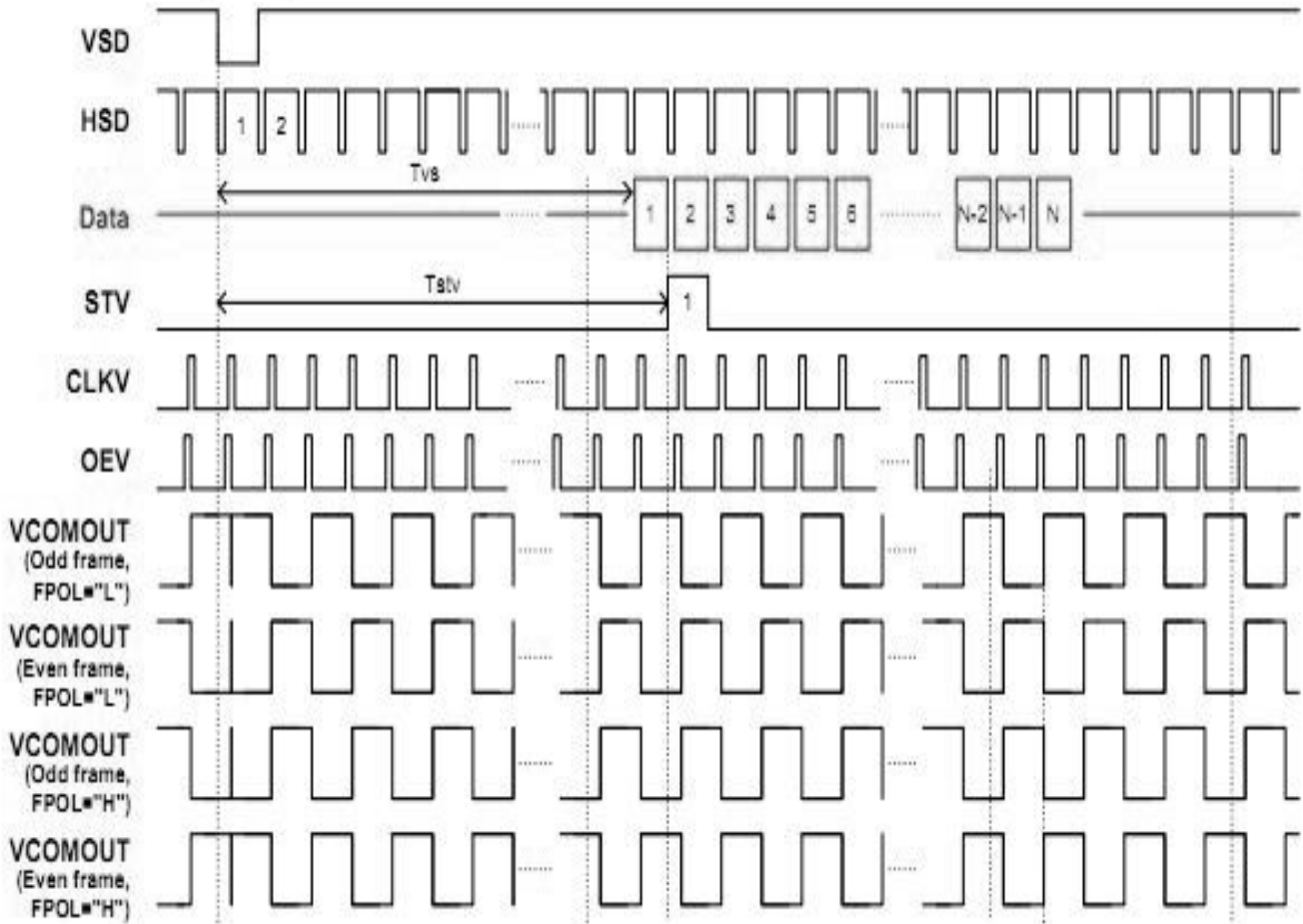
**Clock and Data Input Timing Diagram**



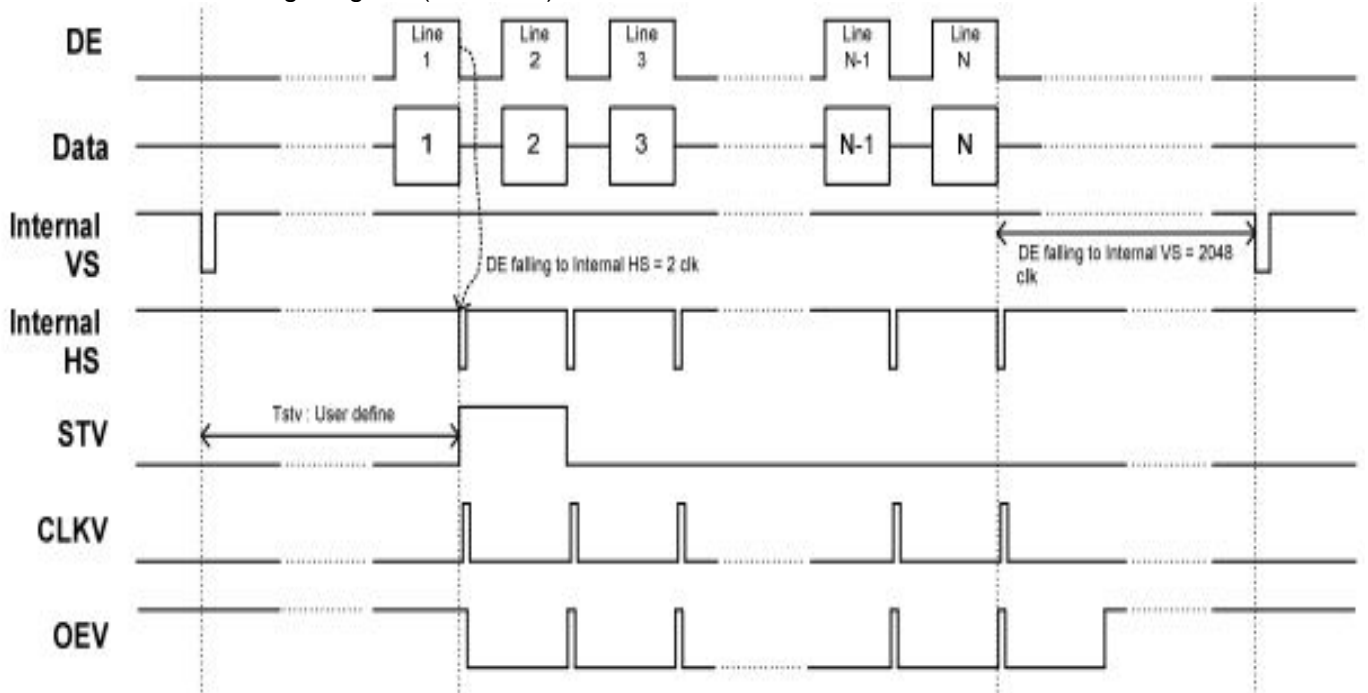
**3-Wire Timing Diagram**



8.4 Vertical Timing Diagram (HV Mode)

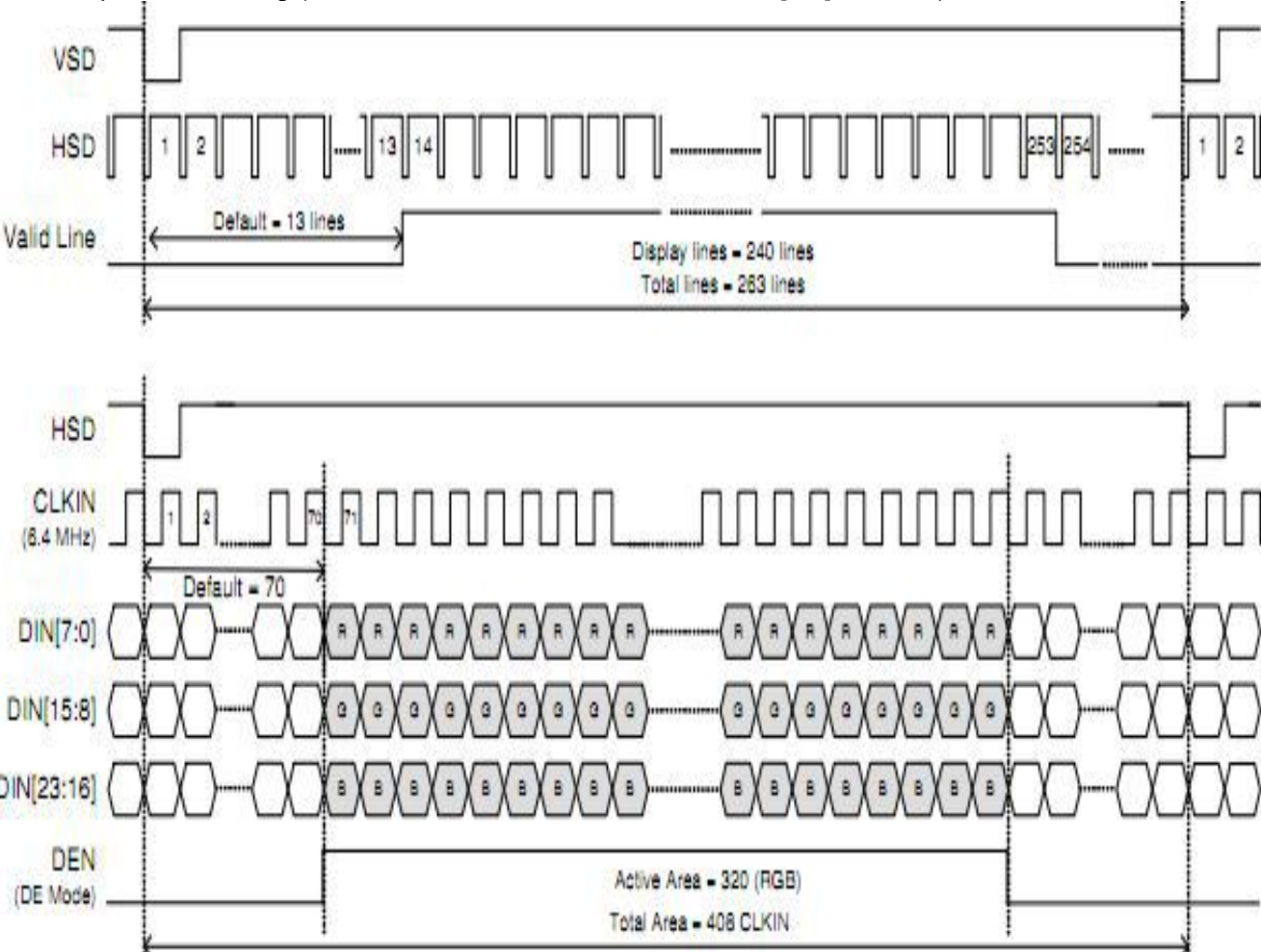


8.5 Vertical Timing Diagram (DE Mode)



# ASI-T-350EA6AN/D

## 8.6 Input Data Timing (24 bit RGB mode for 960 x 240 @ SEL[3:0] = 1100b)



9. Optical Specification

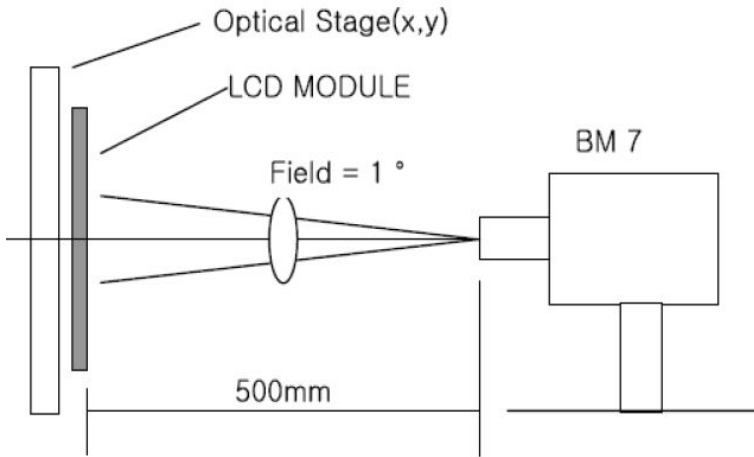
Ta=25°C

Item	Symbol	Condition	Min	Typ.	Max.	Unit	Remark
Contrast Ratio	CR	$\theta=0^\circ$	-	350	-		Note1 Note2
Response Time	Ton/ Toff	25°C	-	25	40	ms	Note1 Note3
View Angles	$\theta T$	$CR \geq 10$	30	40	-	Degree	Note 4
	$\theta B$		50	60	-		
	$\theta L$		50	60	-		
	$\theta R$		50	60	-		
Chromaticity	Red	Brightness is on	x	0.586	0.636	0.686	Note5, Note1
			y	0.300	0.350	0.400	
	Green		x	0.261	0.311	0.361	
			y	0.501	0.551	0.601	
	Blue		x	0.084	0.134	0.184	
			y	0.101	0.151	0.201	
	White		x	0.261	0.311	0.361	
			y	0.300	0.353	0.400	
NTSC				50		%	Note 5
Luminance	L		550	600	-	cd/m <sup>2</sup>	Note1 Note6
Uniformity	U		75	80	-	%	Note1 Note7

Note 1: Definition of optical measurement system.

Temperature = 25°C (±3°C)

LED back-light: ON, Environment brightness < 150 lx

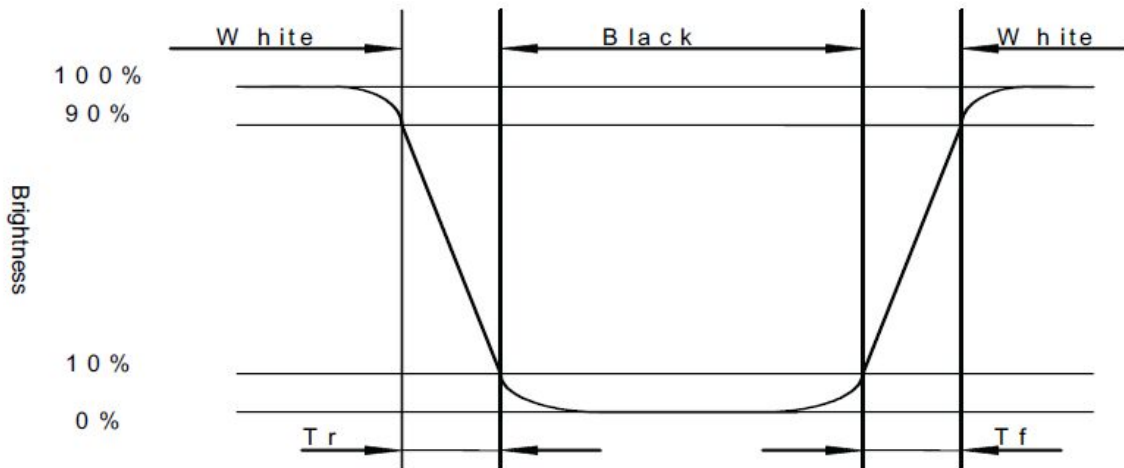


Note 2: Contrast ratio is defined as follow:

$$\text{Contrast Ratio} = \frac{\text{Surface Luminance with all white pixels}}{\text{Surface Luminance with all black pixels}}$$

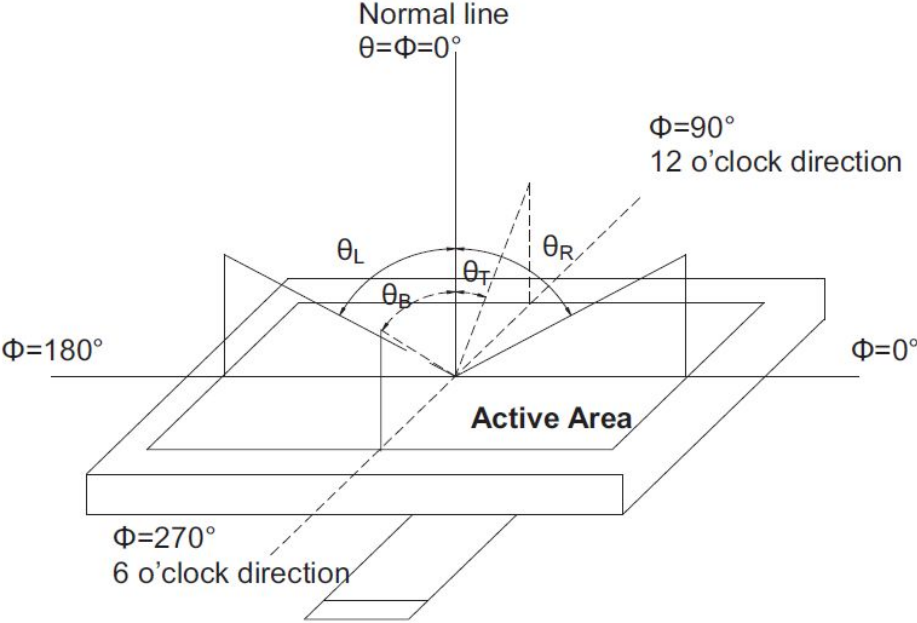
Note 3: Response time is defined as follow:

Response time is the time required for the display to transition from black to white (Rise Time, Tr) and from white to black (Decay Time, Tf).



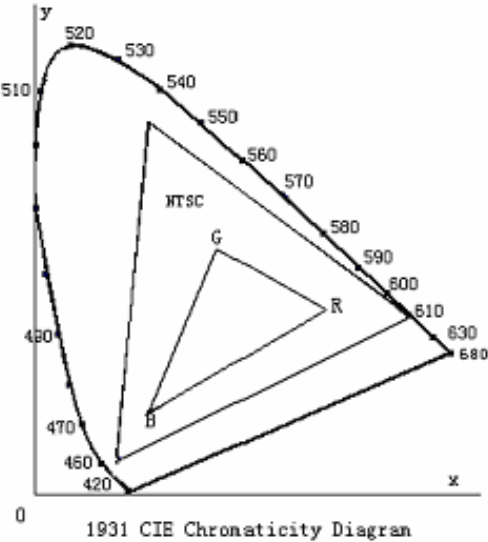
Note 4: Viewing angle range is defined as follow:

Viewing angle is measured at the center point of the LCD.



Note 5: Color chromaticity is defined as follow: (CIE1931)

Color coordinates measured at center point of LCD.



$$S = \frac{\text{area of RGB triangle}}{\text{area of NTSC triangle}} \times 100\%$$

Note 6: Luminance is defined as follow:

Luminance is defined as the brightness of all pixels “White” at the center of display area on optimum contrast.

Note 7: Luminance Uniformity is defined as follow:

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

$$\text{Uniformity (U)} = \frac{\text{Minimum Luminance( brightness ) in 9 points}}{\text{Maximum Luminance( brightness ) in 9 points}}$$

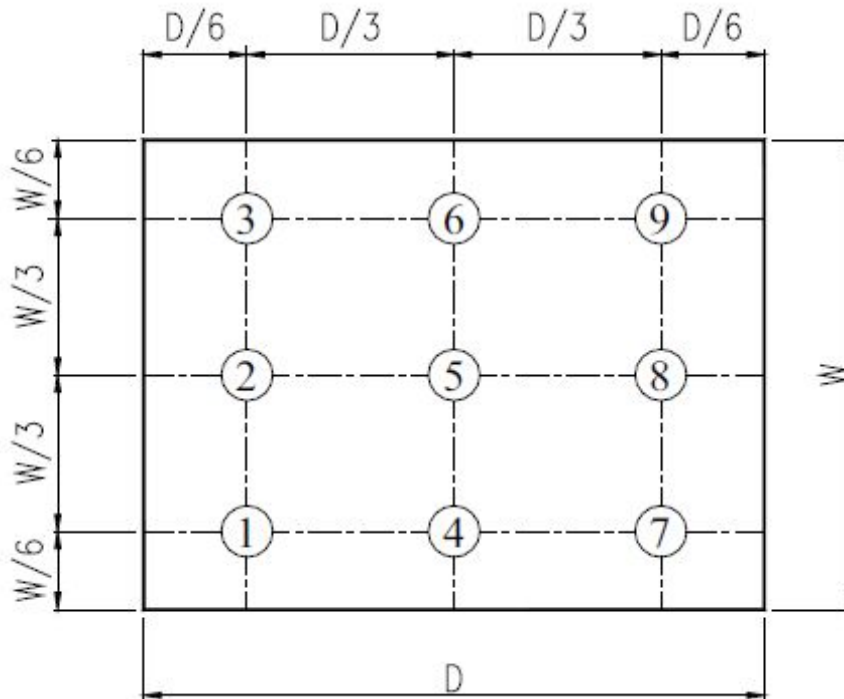


Fig. 2 Definition of uniformity

10. Environmental / Reliability Tests

No	Test Item	Condition	Judgment criteria
1	High Temp Operation	Ts=+70°C, 120hrs	Per table in below
2	Low Temp Operation	Ta=-20°C, 120hrs	Per table in below
3	High Temp Storage	Ta=+80°C, 120hrs	Per table in below
4	Low Temp Storage	Ta=-30°C, 120hrs	Per table in below
5	High Temp & High Humidity Storage	Ta=+60°C, 90% RH 120 hours	Per table in below (polarizer discoloration is excluded)
6	Thermal Shock (Non-operation)	-30°C 30 min~+80°C 30 min, Change time:5min, 10 Cycles	Per table in below
7	ESD (Operation)	C=150pF, R=330Ω · 5points/panel Air:±8KV, 5times; Contact:±4KV, 5 times;	Per table in below
8	Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z.	Per table in below
9	Shock (Non-operation)	60G 6ms, ±X,±Y,±Z 3times, for each direction	Per table in below
10	Package Drop Test	Height:80 cm, 1 corner, 3 edges, 6 surfaces	Per table in below

INSPECTION	CRITERION(after test)
Appearance	No Crack on the FPC, on the LCD Panel
Alignment of LCD Panel	No Bubbles in the LCD Panel No other Defects of Alignment in Active area
Electrical current	Within device specifications
Function / Display	No Broken Circuit, No Short Circuit or No Black line No Other Defects of Display



## 11. Precautions for Use of LCD Modules

### 11.1 Safety

The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

### 11.2 Handling

- A. The LCD and touch panel is made of plate glass. Do not subject the panel to mechanical shock or to excessive force on its surface.
- B. Do not handle the product by holding the flexible pattern portion in order to assure the reliability
- C. Transparency is an important factor for the touch panel. Please wear clear finger sacks, gloves and mask to protect the touch panel from finger print or stain and also hold the portion outside the view area when handling the touch panel.
- D. Provide a space so that the panel does not come into contact with other components.
- E. To protect the product from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.
- F. Transparent electrodes may be disconnected if the panel is used under environmental conditions where dew condensation occurs.
- G. Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.
- H. To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

### 11.3 Static Electricity

- A. Ground soldering iron tips, tools and testers when they are in operation.
- B. Ground your body when handling the products.
- C. Power on the LCD module before applying the voltage to the input terminals.
- D. Do not apply voltage which exceeds the absolute maximum rating.
- E. Store the products in an anti-electrostatic bag or container.

### 11.4 Storage

- A. Store the products in a dark place at  $+25^{\circ}\text{C} \pm 10^{\circ}\text{C}$  with low humidity (40% RH to 60% RH). Don't expose to sunlight or fluorescent light.
- B. Storage in a clean environment, free from dust, active gas, and solvent.

### 11.5 Cleaning

- A. Do not wipe the touch panel with dry cloth, as it may cause scratch.
- B. Wipe off the stain on the product by using soft cloth moistened with ethanol. Do not allow ethanol to get in between the upper film and the bottom glass. It may cause peeling issue or defective operation. Do not use any organic solvent or detergent other than ethanol.

### 11.6 Cautions for installing and assembling

Bezel edge must be positioned in the area between the Active area and View area. The bezel may press the touch screen and cause activation if the edge touches the active area. A gap of approximately 0.5mm is needed between the bezel and the top electrode. It may cause unexpected activation if the gap is too narrow. There is a tolerance of 0.2 to 0.3mm for the outside dimensions of the touch panel and tail. A gap must be made to absorb the tolerance in the case and connector.

